

High Current SMD Power Bead LPB1208 Series



FEATURES **V**ROHS

- High saturation current
- Low core loss
- Magnetically shielded construction, low radiation
- Compact size & robust ferrite construction
- Operating temperature -55℃ to 125℃ (Including self-heating)
- Surface mount device
- Extremely low DCR

ELECTRICAL SPECIFICATIONS

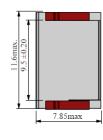
APPLICATIONS

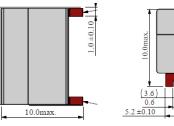
- High speed switch mode application
- Voltage regulator module (VRM)
- CPU/GPU power supply for graphic card or server

PART NUMBER	OCL@550KHz, 0.25Vrms (nH) ±10%	FLL@550KHz, 0.25Vrms (nH) Min.	lsat@ 25±5℃ (Adc)	DCR(mΩ) ±5%	Irms (Adc)
LPB1208R340M-10	340	214	35	0.41	45

Remark:

- 1. OCL is open circuit inductance under specified test conditions without applying DC.
- 2. FLL is full load inductance @25℃ when Isat is applied, Isat is the current at which the inductance will drop within the FLL limit.
- 3. Irms is the current that causes a 40 $^{\circ}$ C temperature rise from 25 $^{\circ}$ C ambient.

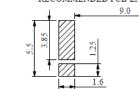






.325 ±0.15

RECOMMENDED PCB LAYOUT





PART NUMBER SYSTEM EXAMPLE

LPB	<u>1208</u>	<u>R340</u>	M	-	<u>10</u>
Product Series	Part Size	Inductance	Tolerance		Standard or Custom
Code	Code	Code	Code		(-10 means standard part)

SCHEMATIC

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USA: +1.423.308.1690 Europe: +42.0.4885.7511.1 Asia: +86.757.2563.8860

MCP-DS-SMD Power Bead 040616

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